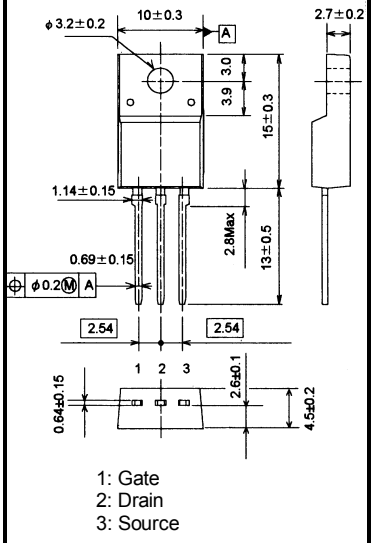
TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIV)

2SK3798

Switching Regulator Applications

- Low drain-source ON resistance: $R_{DS\ (ON)}$ = 2.5 Ω (ty p.)
- High forward transfer admittance: $|Y_{fs}|$ = 2.8 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (V_{DS} = 720 V)
- Enhancement-mode: V_{th} = 2.0~4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Unit: mm



JEDEC	—
JEITA SC-	67
TOSHIBA	2-10U1B

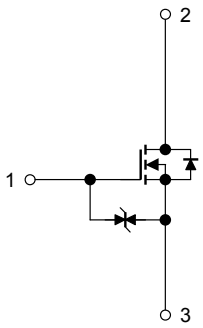
Weight : 1.7 g (typ.)

Maximum Ratings (Ta = 25°C)

Characteristics Sy		mbol	Rating	Unit
Drain-source voltage		V_{DSS}	900	V
Drain-gate voltage (R_{GS} = 20 kΩ)		V_{DGR}	900	V
Gate-source voltage		V_{GSS}	±30	V
Drain current	DC (Note 1)	I_D	4	A
	Pulse (t = 1 ms) (Note 1)	I_{DP}	12	
Drain power dissipation (Tc = 25°C)		P_D	40 W	
Single pulse avalanche energy (Note 2)		E_{AS}	345	mJ
Avalanche current		I_{AR}	4	A
Repetitive avalanche energy (Note 3)		E_{AR}	4.0	mJ
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	-55~150 °	C

Thermal Characteristics

Characteristics Sy	mbol	Max	Unit
Thermal resistance, channel to case	$R_{th\ (ch-c)}$	3.125	°C/W
Thermal resistance, channel to ambient	$R_{th\ (ch-a)}$ 62.	5	°C/W



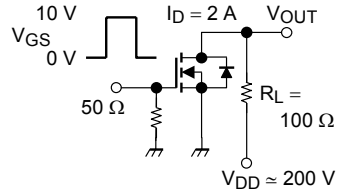
Note 1: Please use devices on conditions that the channel temperature is below 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C, L = 39.6 mH, I_{AR} = 4.0 A, R_G = 25 Ω

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.

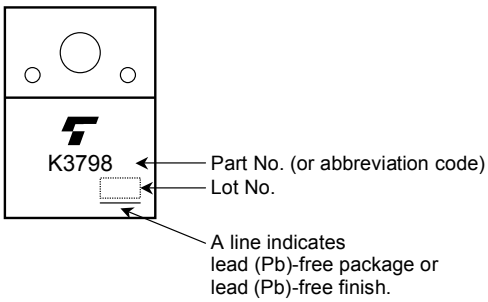
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I_{GSS}	V_{GS} = ±30 V, V_{DS} = 0 V	—	—	±10	μA
Gate-source breakdown voltage	$V_{(BR)\ GSS}$	I_G = ±10 μA, V_{DS} = 0 V	±30	—	—	V
Drain cut-off current	I_{DSS}	V_{DS} = 720 V, V_{GS} = 0 V	—	—	100	μA
Drain-source breakdown voltage	$V_{(BR)\ DSS}$	I_D = 10 mA, V_{GS} = 0 V	900	—	—	V
Gate threshold voltage	V_{th}	V_{DS} = 10 V, I_D = 1 mA	2.0	—	4.0	V
Drain-source ON resistance	$R_{DS\ (ON)}$	V_{GS} = 10 V, I_D = 2 A	—	2.5	3.5	Ω
Forward transfer admittance	$\|Y_{fs}\|$	V_{DS} = 20 V, I_D = 2 A	1.4	2.8	—	S
Input capacitance	C_{iss}	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	—	800	—	pF
Reverse transfer capacitance	C_{rss}		—	20	—	
Output capacitance	C_{oss}		—	85	—	
Switching time — Rise time	t_r		—	20	—	ns
Switching time — Turn-on time	t_{on}		—	65	—	
Switching time — Fall time	t_f		—	45	—	
Switching time — Turn-off time	t_{off}	Duty ≦ 1%, t_w = 10 μs	—	165	—	
Total gate charge	Q_g	V_{DD} ≃ 400 V, V_{GS} = 10 V, I_D = 4 A	—	26	—	nC
Gate-source charge	Q_{gs}		—	14	—	
Gate-drain charge	Q_{gd}		—	12	—	

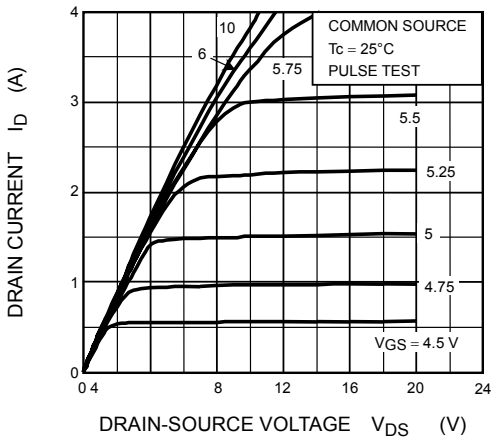
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	4	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	12	A
Forward voltage (diode)	V_{DSF}	I_{DR} = 4 A, V_{GS} = 0 V	—	—	−1.7	V
Reverse recovery time	t_{rr}	I_{DR} = 4 A, V_{GS} = 0 V, dI_{DR}/dt = 100 A/μs	—	110	—	ns
Reverse recovery charge	Q_{rr}		—	0.83	—	μC

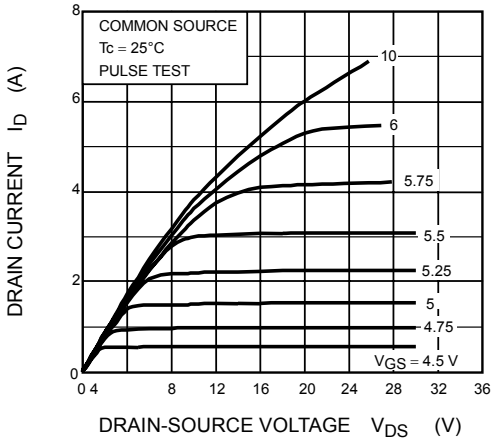
Marking



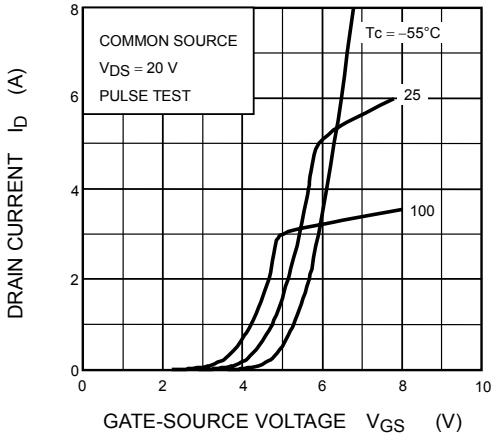
$I_D - V_{DS}$



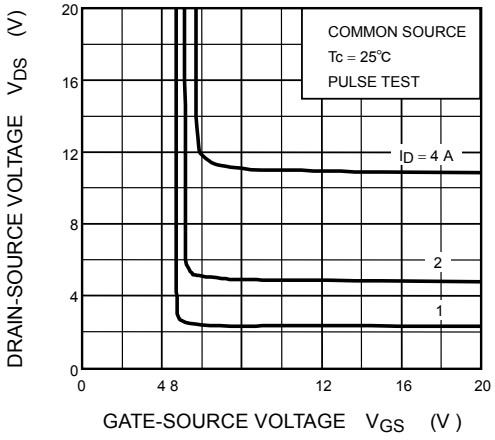
$I_D - V_{DS}$



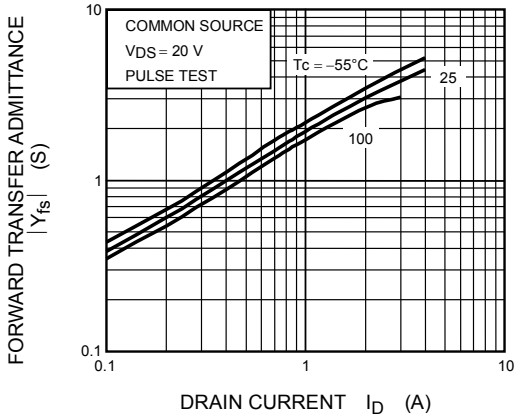
$I_D - V_{GS}$



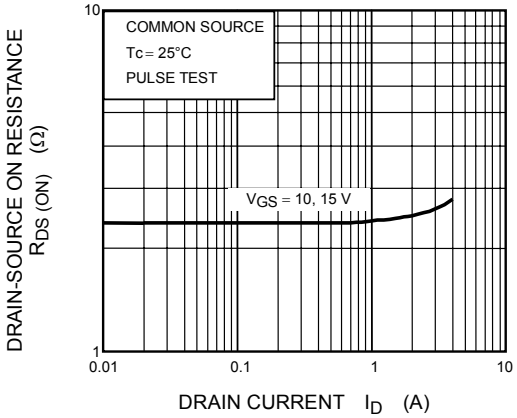
$V_{DS} - V_{GS}$



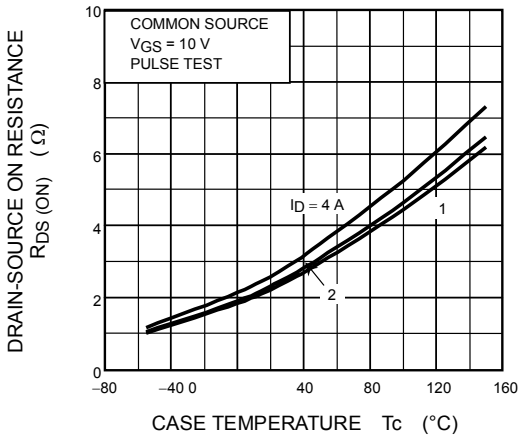
$|Y_{fs}| - I_D$



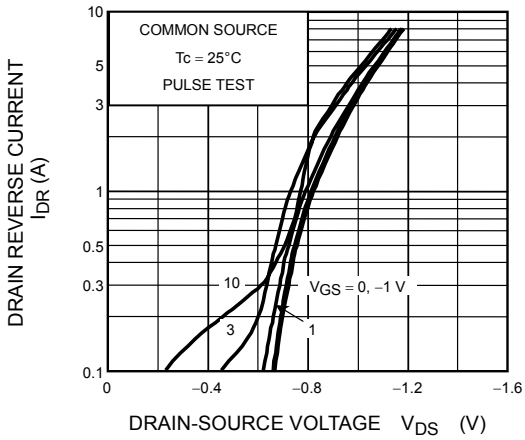
$R_{DS\ (ON)} - I_D$



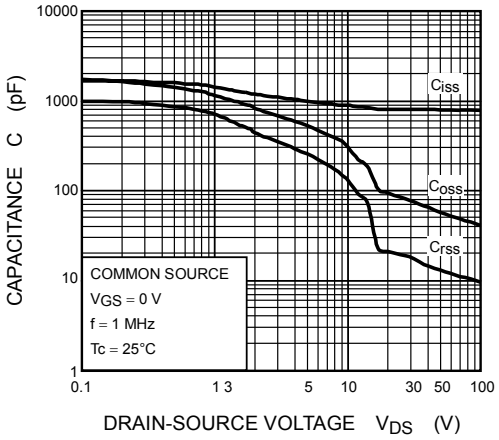
$R_{DS\ (ON)}$ – Tc



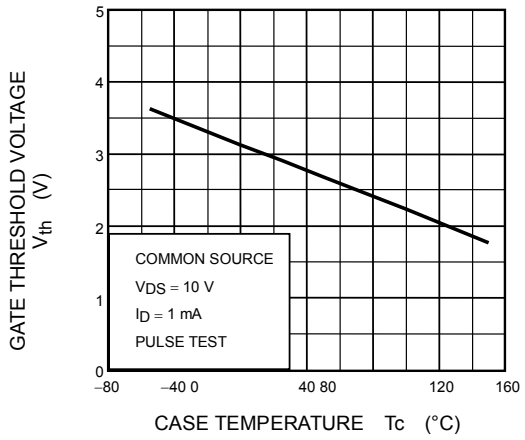
I_{DR} – V_{DS}



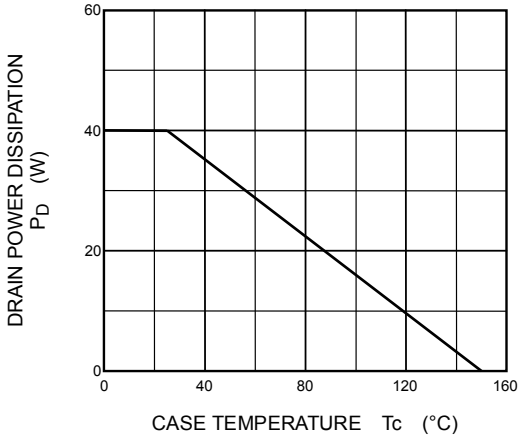
CAPACITANCE – V_{DS}



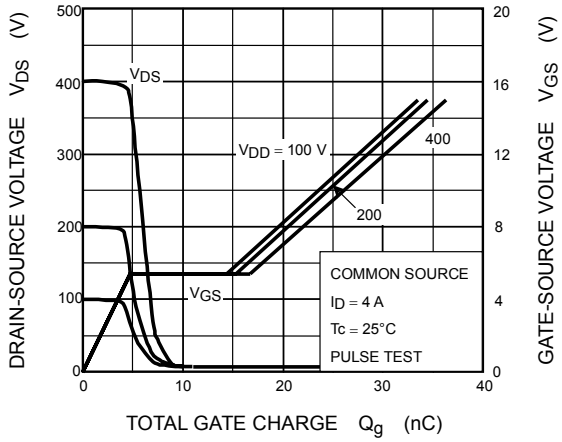
V_{th} – Tc



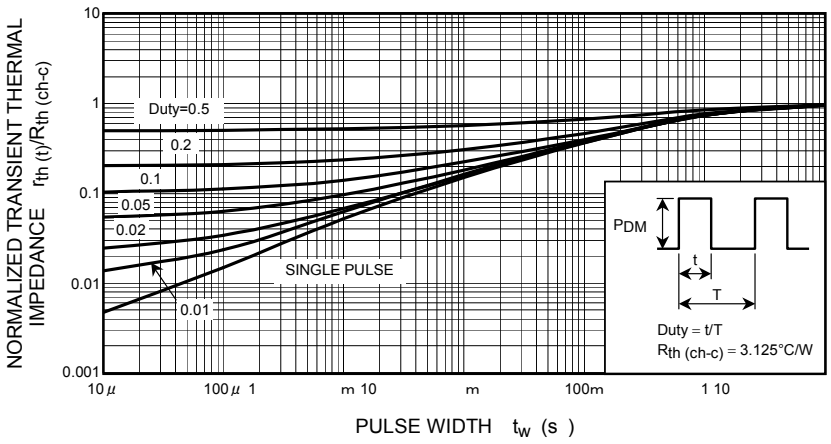
P_D – Tc



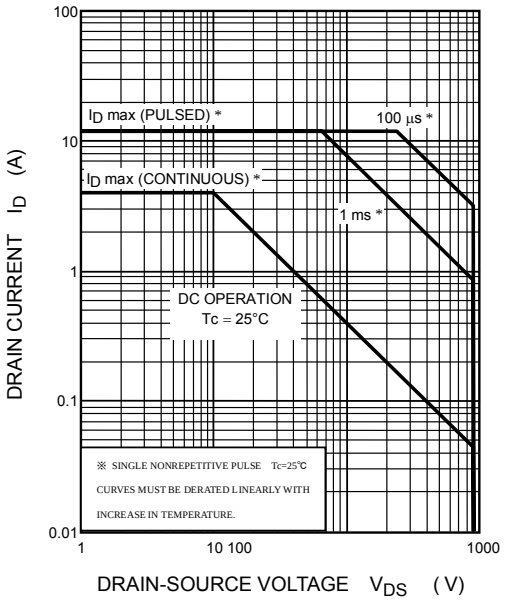
DYNAMIC INPUT / OUTPUT CHARACTERISTICS



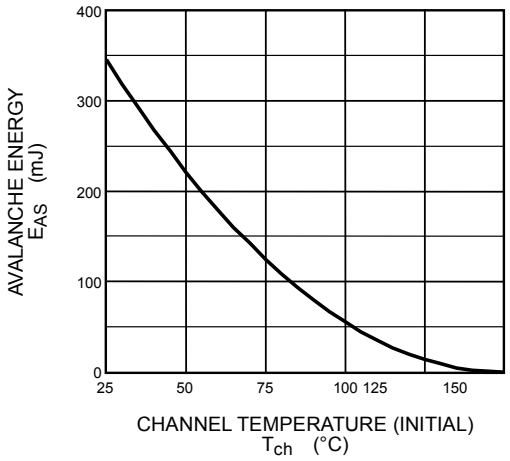
$r_{th} - t_w$

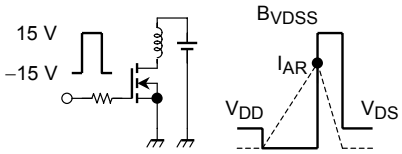


SAFE OPERATING AREA



$E_{AS} - T_{ch}$





TEST CIRCUIT WAVE FORM

$R_G = 25\ \Omega$
$V_{DD} = 90$ V, L = 39.6mH

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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